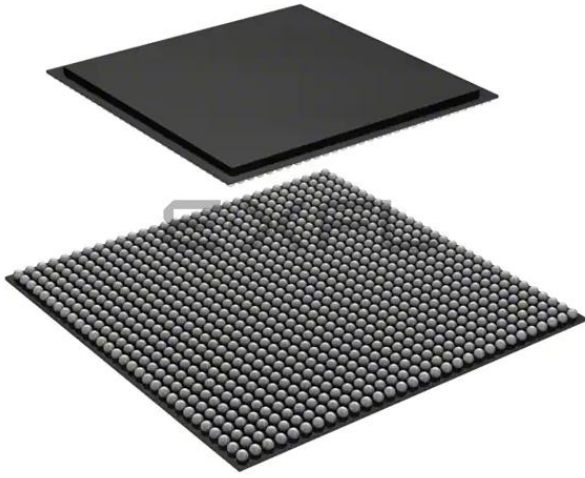




Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

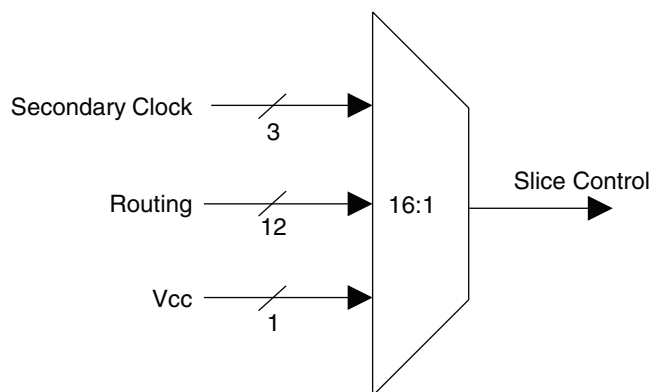
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	8500
Number of Logic Elements/Cells	68000
Total RAM Bits	1056768
Number of I/O	583
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	900-BBGA
Supplier Device Package	900-FPBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-70se-6fn900c

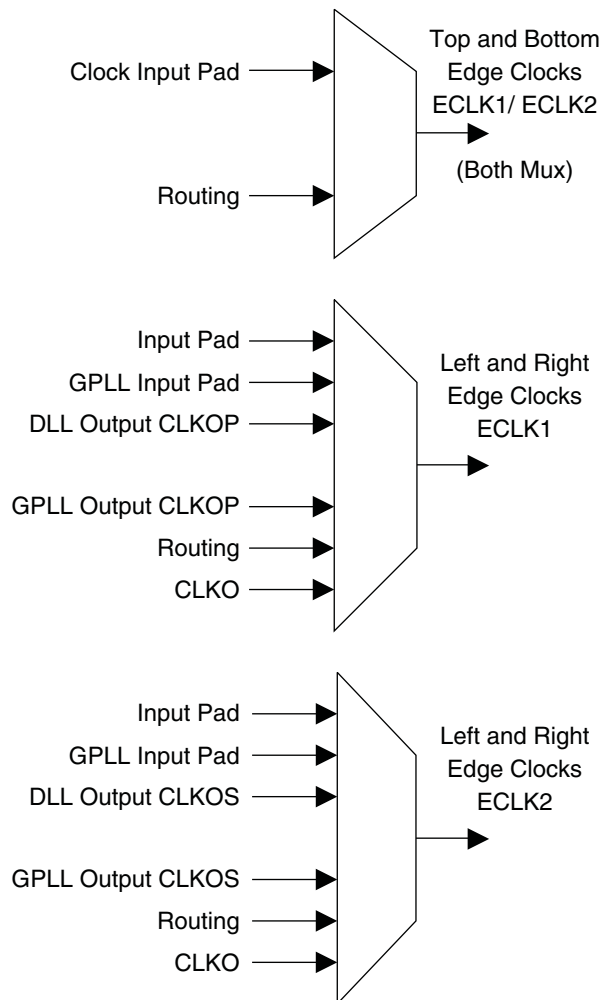
Figure 2-18. Slice0 through Slice2 Control Selection



Edge Clock Routing

LatticeECP2/M devices have a number of high-speed edge clocks that are intended for use with the PIOs in the implementation of high-speed interfaces. There are eight edge clocks per device: two edge clocks per edge. Different PLL and DLL outputs are routed to the two muxes on the left and right sides of the device. In addition, the CLKO signal (generated from the DLLDELA block) is routed to all the edge clock muxes on the left and right sides of the device. Figure 2-19 shows the selection muxes for these clocks.

Figure 2-19. Edge Clock Mux Connections



sets of single-ended input buffers (both ratioed and referenced). One of the referenced input buffers can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

3. Left and Right (Banks 2, 3, 6 and 7) sys/I/O Buffer Pairs (50% Differential and 100% Single-Ended Outputs)

The sys/I/O buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. One of the referenced input buffers can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

LVDS differential output drivers are available on 50% of the buffer pairs on the left and right banks.

4. Bank 8 sys/I/O Buffer Pairs (Single-Ended Outputs, Only on Shared Pins When Not Used by Configuration)

The sys/I/O buffers in Bank 8 consist of single-ended output drivers and single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

In LatticeECP2 devices, only the I/Os on the bottom banks have programmable PCI clamps. In LatticeECP2M devices, the I/Os on the left and bottom banks have programmable PCI clamps.

Typical sys/I/O I/O Behavior During Power-up

The internal power-on-reset (POR) signal is deactivated when V_{CC} , V_{CCIO8} and V_{CCAUX} have reached satisfactory levels. After the POR signal is deactivated, the FPGA core logic becomes active. It is the user's responsibility to ensure that all other V_{CCIO} banks are active with valid input logic levels to properly control the output logic states of all the I/O banks that are critical to the application. For more information about controlling the output logic state with valid input logic levels during power-up in LatticeECP2/M devices, see the list of additional technical documentation at the end of this data sheet.

The V_{CC} and V_{CCAUX} supply the power to the FPGA core fabric, whereas the V_{CCIO} supplies power to the I/O buffers. In order to simplify system design while providing consistent and predictable I/O behavior, it is recommended that the I/O buffers be powered-up prior to the FPGA core fabric. V_{CCIO} supplies should be powered-up before or together with the V_{CC} and V_{CCAUX} supplies.

Prior to and throughout programming of the FPGA, the I/O of the device have a weak-pullup resistor to V_{CCIO} on the input buffer and the output buffer is tri-stated. A pullup to V_{CCIO} is present on the input until the user programs the input differently in the FPGA design. See the [DC Electrical Characteristics](#) table of this data sheet. The pullup value will be between 20-30K ohms based on the V_{CCIO} voltage supplied on the board. This pullup will also remain active if the design does not use a particular I/O.

Supported sys/I/O Standards

The LatticeECP2/M sys/I/O buffer supports both single-ended and differential standards. Single-ended standards can be further subdivided into LVCMOS, LVTTTL and other standards. The buffers support the LVTTTL, LVCMOS 1.2V, 1.5V, 1.8V, 2.5V and 3.3V standards. In the LVCMOS and LVTTTL modes, the buffer has individual configuration options for drive strength, bus maintenance (weak pull-up, weak pull-down, or a bus-keeper latch) and open drain. Other single-ended standards supported include SSTL and HSTL. Differential standards supported include LVDS, MLVDS, BLVDS, LVPECL, RSQS, differential SSTL and differential HSTL. Tables 2-13 and 2-14 show the I/

Table 2-14. Supported Output Standards

Output Standard	Drive	V _{CCIO} (Nom.)
Single-ended Interfaces		
LVTTL	4mA, 8mA, 12mA, 16mA, 20mA	3.3
LVC MOS33	4mA, 8mA, 12mA 16mA, 20mA	3.3
LVC MOS25	4mA, 8mA, 12mA, 16mA, 20mA	2.5
LVC MOS18	4mA, 8mA, 12mA, 16mA	1.8
LVC MOS15	4mA, 8mA	1.5
LVC MOS12	2mA, 6mA	1.2
LVC MOS33, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS25, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS18, Open Drain	4mA, 8mA, 12mA 16mA	—
LVC MOS15, Open Drain	4mA, 8mA	—
LVC MOS12, Open Drain	2mA, 6mA	—
PCI33	N/A	3.3
HSTL18 Class I, II	N/A	1.8
HSTL15 Class I	N/A	1.5
SSTL3 Class I, II	N/A	3.3
SSTL2 Class I, II	N/A	2.5
SSTL18 Class I, II	N/A	1.8
Differential Interfaces		
Differential SSTL3, Class I, II	N/A	3.3
Differential SSTL2, Class I, II	N/A	2.5
Differential SSTL18, Class I, II	N/A	1.8
Differential HSTL18, Class I, II	N/A	1.8
Differential HSTL15, Class I	N/A	1.5
LVDS	N/A	2.5
MLVDS ¹	N/A	2.5
BLVDS ¹	N/A	2.5
LVPECL ¹	N/A	3.3
RSDS ¹	N/A	2.5
LVC MOS33D ¹	4mA, 8mA, 12mA, 16mA, 20mA	3.3

1. Emulated with external resistors. For more detail, please see information regarding additional technical documentation at the end of this data sheet.

Hot Socketing

LatticeECP2/M devices have been carefully designed to ensure predictable behavior during power-up and power-down. During power-up and power-down sequences, the I/Os remain in tri-state until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled within specified limits. This allows for easy integration with the rest of the system. These capabilities make the LatticeECP2/M ideal for many multiple power supply and hot-swap applications.



LatticeECP2/M Family Data Sheet

DC and Switching Characteristics

September 2013

Data Sheet DS1006

Absolute Maximum Ratings^{1, 2, 3}

Supply Voltage V_{CC} -0.5 to 1.32V

Supply Voltage V_{CCAUX} -0.5 to 3.75V

Supply Voltage V_{CCJ} -0.5 to 3.75V

Output Supply Voltage V_{CCIO} -0.5 to 3.75V

Input or I/O Tristate Voltage Applied⁴ -0.5 to 3.75V

Storage Temperature (Ambient) -65 to 150°C

Junction Temperature (T_j) +125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice [Thermal Management](#) document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to ($V_{IHMAX} + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions⁷

Symbol	Parameter	Min.	Max.	Units
$V_{CC}^{1, 4, 5}$	Core Supply Voltage	1.14	1.26	V
$V_{CCAUX}^{1, 3, 4, 5}$	Auxiliary Supply Voltage	3.135	3.465	V
V_{CCPLL}	PLL Supply Voltage	1.14	1.26	V
$V_{CCIO}^{1, 2, 4}$	I/O Driver Supply Voltage	1.14	3.465	V
V_{CCJ}^1	Supply Voltage for IEEE 1149.1 Test Access Port	1.14	3.465	V
t_{JCOM}	Junction Temperature, Commercial Operation	0	85	°C
t_{JIND}	Junction Temperature, Industrial Operation	-40	100	°C
SERDES External Power Supply (For LatticeECP2M Family Only)				
V_{CCIB}	Input Buffer Power Supply (1.2V)	1.14	1.26	V
	Input Buffer Power Supply (1.5V)	1.425	1.575	V
V_{CCOB}	Output Buffer Power Supply (1.2V)	1.14	1.26	V
	Output Buffer Power Supply (1.5V)	1.425	1.575	V
$V_{CCAUX33}$	Termination Resistor Switching Power Supply	3.135	3.465	V
V_{CCR}^6	Receive Power Supply	1.14	1.26	V
V_{CCT}^6	Transmit Power Supply	1.14	1.26	V

Typical Building Block Function Performance¹

Pin-to-Pin Performance (LVCMOS25 12mA Drive)

Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	3.8	ns
32-bit Decoder	4.5	ns
64-bit Decoder	5.0	ns
4:1 MUX	3.2	ns
8:1 MUX	3.4	ns
16:1 MUX	3.5	ns
32:1 MUX	4.0	ns

1. These timing numbers were generated using the ispLEVER 8.0 design tool. Exact performance may vary with device and tool version. The tool uses internal parameters that have been characterized but are not tested on every device.

Register-to-Register Performance

Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	599	MHz
32-bit Decoder	542	MHz
64-bit Decoder	417	MHz
4:1 MUX	847	MHz
8:1 MUX	803	MHz
16:1 MUX	660	MHz
32:1 MUX	577	MHz
8-bit Adder	591	MHz
16-bit Adder	500	MHz
64-bit Adder	306	MHz
16-bit Counter	488	MHz
32-bit Counter	378	MHz
64-bit Counter	260	MHz
64-bit Accumulator	253	MHz
Embedded Memory Functions		
512x36 Single Port RAM, EBR Output Registers	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, EBR Output Registers)	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, PLC Output Registers)	280	MHz
Distributed Memory Functions		
16x4 Pseudo-Dual Port RAM (One PFU)	819	MHz
32x4 Pseudo-Dual Port RAM	521	MHz
64x8 Pseudo-Dual Port RAM	435	MHz
DSP Functions		
18x18 Multiplier (All Registers)	420	MHz
9x9 Multiplier (All Registers)	420	MHz

LatticeECP2/M Internal Switching Characteristics¹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{HWREN_EBR}	Hold Write/Read Enable to PFU Memory	0.139	—	0.156	—	0.173	—	ns
t _{SUCE_EBR}	Clock Enable Setup Time to EBR Output Register	0.123	—	0.134	—	0.145	—	ns
t _{HCE_EBR}	Clock Enable Hold Time to EBR Output Register	-0.081	—	-0.090	—	-0.100	—	ns
t _{RSTO_EBR}	Reset To Output Delay Time from EBR Output Register	—	1.03	—	1.15	—	1.26	ns
t _{SUBE_EBR}	Byte Enable Set-Up Time to EBR Output Register	-0.115	—	-0.130	—	-0.145	—	ns
t _{HBE_EBR}	Byte Enable Hold Time to EBR Output Register	0.138	—	0.155	—	0.172	—	ns
GPLL Parameters								
t _{RSTREC_GPLL}	Reset Recovery to Rising Clock	1.00	—	1.00	—	1.00	—	ns
SPLL Parameters								
t _{RSTREC_SPLL}	Reset Recovery to Rising Clock	1.00	—	1.00	—	1.00	—	ns
DSP Block Timing^{2,3}								
t _{SUI_DSP}	Input Register Setup Time	0.12	—	0.13	—	0.14	—	ns
t _{HI_DSP}	Input Register Hold Time	0.02	—	-0.01	—	-0.03	—	ns
t _{SUP_DSP}	Pipeline Register Setup Time	2.18	—	2.42	—	2.66	—	ns
t _{HP_DSP}	Pipeline Register Hold Time	-0.68	—	-0.77	—	-0.86	—	ns
t _{SUO_DSP}	Output Register Setup Time	4.26	—	4.71	—	5.16	—	ns
t _{HO_DSP}	Output Register Hold Time	-1.25	—	-1.40	—	-1.54	—	ns
t _{COI_DSP}	Input Register Clock to Output Time	—	3.92	—	4.30	—	4.68	ns
t _{COP_DSP}	Pipeline Register Clock to Output Time	—	1.87	—	1.98	—	2.08	ns
t _{COO_DSP}	Output Register Clock to Output Time	—	0.50	—	0.52	—	0.55	ns
t _{SUADDSUB}	AddSub Input Register Setup Time	-0.24	—	-0.26	—	-0.28	—	ns
t _{HADDSUB}	AddSub Input Register Hold Time	0.27	—	0.29	—	0.32	—	ns

1. Internal parameters are characterized but not tested on every device.

2. These parameters apply to LatticeECP devices only.

3. DSP Block is configured in Multiply Add/Sub 18x18 Mode.

SERDES High-Speed Data Transmitter (LatticeECP2M Family Only)^{1, 2}

Table 3-7. Serial Output Timing and Levels

Symbol	Description	Frequency	Min.	Typ.	Max.	Units
V _{TX-DIFF-P-P-1}	Differential swing (1V setting) ^{1, 2}	0.25 to 3.125 Gbps	0.79	0.99	1.19	V, p-p
V _{TX-DIFF-P-P-1.25}	Differential swing (1.25V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.00	1.25	1.50	V, p-p
V _{TX-DIFF-P-P-1.3}	Differential swing (1.3V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.04	1.30	1.56	V, p-p
V _{TX-DIFF-P-P-1.35}	Differential swing (1.35V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.08	1.35	1.62	V, p-p
V _{OCM}	Output common mode voltage	—	V _{CCOB} - 0.75	V _{CCOB} - 0.60	V _{CCOB} - 0.45	V
T _{TX-R}	Rise time (20% to 80%)	—	—	70	—	ps
T _{TX-F}	Fall time (80% to 20%)	—	—	70	—	ps
Z _{TX-OI-SE}	Output impedance 50/75/HiZ K Ohms (single-ended)	—	—	50/70 HiZ	—	Ohms
R _{TX-RL}	Return loss (with package)	—	—	9	—	dB

1. All measurements are with 50 ohm impedance.

2. See TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#) for actual binary settings.

Table 3-8. Channel Output Jitter - x10 Mode

Description	Frequency	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	—	0.08	0.12	UI, p-p
Random	3.125 Gbps	—	0.22	0.38	UI, p-p
Total	3.125 Gbps	—	0.33	0.43	UI, p-p
Deterministic	2.5 Gbps	—	0.08	0.17	UI, p-p
Random	2.5 Gbps	—	0.20	0.25	UI, p-p
Total	2.5 Gbps	—	0.25	0.35	UI, p-p
Deterministic	1.25 Gbps	—	0.03	0.10	UI, p-p
Random	1.25 Gbps	—	0.14	0.19	UI, p-p
Total	1.25 Gbps	—	0.17	0.24	UI, p-p
Deterministic	250 Mbps	—	0.04	0.17	UI, p-p
Random	250 Mbps	—	0.12	0.13	UI, p-p
Total	250 Mbps	—	0.15	0.29	UI, p-p

Note: Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x10 mode.

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Byte Data Flow				
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7	—	ns
$t_{HCB DI}$	Byte D[0:7] Hold Time to CCLK	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
t_{SUCS}	CSN[0:1] Setup Time to CCLK	7	—	ns
t_{HCS}	CSN[0:1] Hold Time to CCLK	1	—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7	—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1	—	ns
t_{DCB}	CCLK to BUSY Delay Time	—	12	ns
t_{CORD}	CCLK to Out for Read Data	—	12	ns
sysCONFIG Byte Slave Clocking				
t_{BSCH}	Byte Slave CCLK Minimum High Pulse	6	—	ns
t_{BSCL}	Byte Slave CCLK Minimum Low Pulse	9	—	ns
t_{BSCYC}	Byte Slave CCLK Cycle Time	15	—	ns
sysCONFIG Serial (Bit) Data Flow				
t_{SUSCDI}	DI Setup Time to CCLK Slave Mode	7	—	ns
t_{HSCDI}	DI Hold Time to CCLK Slave Mode	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
sysCONFIG Serial Slave Clocking				
t_{SSCH}	Serial Slave CCLK Minimum High Pulse	6	—	ns
t_{SSCL}	Serial Slave CCLK Minimum Low Pulse	6	—	ns
sysCONFIG POR, Initialization and Wake-up				
t_{ICFG}	Minimum Vcc to INITN High	—	28	ms
t_{VMC}	Time from t_{ICFG} to Valid Master CCLK	—	2	us
t_{PRGMRJ}	PROGRAMN Pin Pulse Rejection	—	8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25	—	ns
t_{DINIT}	PROGRAMN High to INITN High Delay ¹	—	1.5	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INITN Low	—	37	ns
$t_{DPPDONE}$	Delay Time from PROGRAMN Low to DONE Low	—	37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—	35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake-up Sequence	—	25	ns
t_{MWC}	Additional Wake Master Clock Signals after DONE Pin High	120	—	cycles
sysCONFIG SPI Port²				
t_{CFGX}	INITN High to CCLK Low	—	1	μs
t_{CSSPI}	INITN High to CSSPIN Low	—	2	us
t_{CSCCLK}	CCLK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CCLK Low to Output Valid	—	15	ns
t_{SOE}	CSSPIN[0:1] Active Setup Time	300	—	ns
t_{CSPID}	CSSPIN[0:1] Low to First CCLK Edge Setup Time	300+3cyc	600+6cyc	ns

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]_SQ_VCCI _{Bm}	—	Input buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_VCCO _{Bm}	—	Output buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_HDOU _{TNm}	O	High-speed output, negative channel m
[LOC]_SQ_HDOU _{TPm}	O	High-speed output, positive channel m
[LOC]_SQ_HDIN _{Nm}	I	High-speed input, negative channel m
[LOC]_SQ_HDIN _{Pm}	I	High-speed input, positive channel m
[LOC]_SQ_VCCT _{Xm} ⁴	—	Transmitter power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.
[LOC]_SQ_VCCR _{Xm} ⁴	—	Receiver power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.

1. These signals are relevant for LatticeECP2M family.
2. m defines the associated channel in the Quad.
3. These signals are defined in Quads [LOC] indicates the corner SERDES Quad is located: ULC (upper left), URC (upper right), LLC (lower left), LRC (lower right).
4. When placing switching I/Os around these critical pins that are designed to supply the device with the proper reference or supply voltage, care must be given. For more information, refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#).
5. There may be SPLs that do not have dedicated I/Os.

LatticeECP2 Pin Information Summary, LFE2-6 and LFE2-12

Pin Type		LFE2-6		LFE2-12			
		144 TQFP	256 fpBGA	144 TQFP	208 PQFP	256 fpBGA	484 fpBGA
Single Ended User I/O		90	190	93	131	193	297
Differential Pair User I/O		43	95	45	62	96	148
Configuration	TAP Pins	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7
Non Configuration	Muxed Pins	34	54	33	40	54	57
	Dedicated Pins	3	3	3	3	3	3
VCC		10	7	10	14	7	16
VCCAUX		4	4	4	8	4	16
VCCPLL		0	0	0	0	0	0
VCCIO	Bank0	1	2	1	2	2	4
	Bank1	1	2	1	2	2	4
	Bank2	1	2	1	2	2	4
	Bank3	1	2	1	2	2	4
	Bank4	1	2	1	2	2	4
	Bank5	1	2	1	2	2	4
	Bank6	1	2	1	2	2	4
	Bank7	1	2	1	2	2	4
	Bank8	1	1	1	2	1	2
GND, GND0 to GND7		12	20	12	22	20	60
NC		4	3	1	0	0	44
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	8/4	18/6	8/4	18/9	18/9	50/25
	Bank1	17/8	34/17	18/9	18/9	34/17	46/23
	Bank2	4/2	20/10	4/2	11/5	20/10	24/12
	Bank3	8/4	12/6	8/4	11/5	12/6	16/8
	Bank4	18/9	32/16	18/9	19/9	32/16	46/23
	Bank5	8/4	14/7	10/5	18/9	17/8	46/23
	Bank6	9/4	26/13	9/4	18/8	26/13	32/16
	Bank7	12/6	20/10	12/6	12/6	20/10	23/11
	Bank8	6/2	14/7	6/2	6/2	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0
	Bank2 (Right Edge)	1	5	1	4	5	6
	Bank3 (Right Edge)	3	3	3	3	3	4
	Bank4 (Bottom Edge)	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0
	Bank6 (Left Edge)	2	7	2	6	7	8
	Bank7 (Left Edge)	5	5	5	5	5	5
	Bank8 (Right Edge)	0	0	0	0	0	0

LatticeECP2 Power Supply and NC (Cont.)

Signals	672 fpBGA ³	900 fpBGA ³
VCC	LFE2-20: R8, P18, M8, L20, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2-35/LFE2-50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2-70: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15	AA11, AA20, K11, K21, K22, L11, L12, L13, L18, L19, L20, M11, M20, N11, N20, V11, V20, W11, W20, Y10, Y11, Y12, Y13, Y18, Y19, Y20
VCCIO0	D11, D6, G9, J12, K12	J13, J14, K12, K13, K14, K15
VCCIO1	D16, D21, G18, J15, K15	J17, J18, J20, K17, K18, K20
VCCIO2	F23, J20, L23, M17, M18	L21, M21, M22, N21, N22, R21
VCCIO3	AA23, R17, R18, T23, V20	U21, U22, V21, V22, W21, Y22
VCCIO4	AC16, AC21, U15, V15, Y18	AA16, AA17, AA18, AA19, AB17, AB18
VCCIO5	AC11, AC6, U12, V12, Y9	AA12, AA13, AA14, AB12, AB13, AB14
VCCIO6	AA4, R10, R9, T4, V7	U10, U9, V10, W10, W9, Y9
VCCIO7	F4, J7, L4, M10, M9	L10, L9, M10, N10, P10, R10
VCCIO8	AE25, V18	AA21, Y21
VCCJ	AB5	AD3
VCCAUX	J10, J11, J16, J17, K18, L18, T18, U18, V16, V17, V10, V11, T9, U9, K9, L9	AA15, AB11, AB19, AB20, J11, J12, J19, K19, L22, M9, N9, P21, P9, T10, T21, V9, W22
VCCPLL	LFE2-20: None LFE2-35/LFE2-70: R8, P18 LFE2-50: R8, P18, M8, L20	P22, P8, T22, Y7
GND ¹	A2, A25, AA18, AA24, AA3, AA9, AD11, AD16, AD21, AD6, AE1, AE26, AF2, AF25, B1, B26, C11, C16, C21, C6, F18, F24, F3, F9, J13, J14, J21, J6, K10, K11, K13, K14, K16, K17, L10, L11, L16, L17, L24, L3, M13, M14, N10, N12, N13, N14, N15, N17, P10, P12, P13, P14, P15, P17, R13, R14, T10, T11, T16, T17, T24, T3, U10, U11, U13, U14, U16, U17, V13, V14, V21, V6	A1, A30, AC28, AC3, AH13, AH18, AH23, AH28, AH3, AH8, AK1, AK30, C13, C18, C23, C28, C3, C8, H28, H3, L14, L15, L16, L17, M12, M13, M14, M15, M16, M17, M18, M19, N12, N13, N14, N15, N16, N17, N18, N19, N28, N3, P11, P12, P13, P14, P15, P16, P17, P18, P19, P20, R11, R12, R13, R14, R15, R16, R17, R18, R19, R20, T11, T12, T13, T14, T15, T16, T17, T18, T19, T20, U11, U12, U13, U14, U15, U16, U17, U18, U19, U20, V12, V13, V14, V15, V16, V17, V18, V19, V28, V3, W12, W13, W14, W15, W16, W17, W18, W19, Y14, Y15, Y16, Y17
NC ²	LFE2-20: E4, E3, E2, E1, H6, H5, F2, F1, H8, J9, G4, G3, K3, K2, K1, L2, L1, M2, M1, N2, T1, T2, P8, P6, P5, P4, U1, V1, P3, R3, R4, U2, V2, W2, T6, R5, AA19, W17, Y19, Y17, AF20, AE20, AA20, W18, AD20, AE21, AF21, AF22, R22, T21, P26, P25, R24, R23, P20, R19, P21, P19, P23, P22, N22, R21, N26, N25, J26, J25, J23, K23, H26, H25, H24, H23, F22, E24, D25, C25, D24, B25, H21, G22, B24, C24, D23, C23, E19, C19, B21, B20, D19, B19, G17, E18, G19, F17, A20, A19, E17, D18, M3, N6, P24 LFE2-35: K3, K2, K1, L2, L1, M2, M1, N2, M8, P3, R3, R4, U2, V2, W2, AF20, AE20, AA20, W18, AD20, AE21, AF21, AF22, P26, P25, R24, R23, P20, R19, L20, J26, J25, J23, K23, H26, H25, H24, H23, E19, C19, B21, B20, D19, B19, G17, E18, G19, F17, A20, A19, E17, D18, M3, N6, P24 LFE2-50: N6, P24, M3 LFE2-70: M8, L20, M3, P24, N6	A2, A3, A4, A5, AB28, AC4, AD23, AE1, AE2, AE29, AE3, AE30, AE4, AE5, AE6, AF1, AF2, AF23, AF26, AF27, AF28, AF29, AF3, AF30, AF4, AF5, AG1, AG13, AG16, AG18, AG2, AG26, AG27, AG28, AG29, AG3, AG30, AG4, AG8, AH1, AH16, AH2, AH26, AH27, AH29, AH30, AH4, AJ1, AJ2, AJ27, AJ28, AJ29, AJ3, AJ30, AK2, AK27, AK28, AK29, AK3, B1, B2, B3, B30, B4, B5, C1, C2, C29, C30, C4, D13, D18, D23, D28, D29, D3, D30, D4, E25, E26, E27, E28, E29, E3, E30, E4, E5, E6, F25, F5, F6, G6, G7, K10, K9, N27, N4, R1, R2, V27, V4

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.

2. NC pins should not be connected to any active signals, VCC or GND.

3. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP

LFE2-6E/SE					LFE2-12E/12SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
1	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
3	PL4A	7		T (LVDS)*	PL4A	7		T (LVDS)*	
4	PL4B	7		C (LVDS)*	PL4B	7		C (LVDS)*	
5	PL6A	7	LDQ10	T (LVDS)*	PL6A	7	LDQ10	T (LVDS)*	
6	VCCAUX	-			VCCAUX	-			
7	PL6B	7	LDQ10	C (LVDS)*	PL6B	7	LDQ10	C (LVDS)*	
8	PL8A	7	LDQ10	T (LVDS)*	PL8A	7	LDQ10	T (LVDS)*	
9	VCCIO7	7			VCCIO7	7			
10	PL8B	7	LDQ10	C (LVDS)*	PL8B	7	LDQ10	C (LVDS)*	
11	GND	-			GND	-			
12	PL12A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ10	T (LVDS)*	
13	PL12B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ10	C (LVDS)*	
14	PL13A	7	PCLKT7_0/LDQ10	T	PL13A	7	PCLKT7_0/LDQ10	T	
15	PL13B	7	PCLKC7_0/LDQ10	C	PL13B	7	PCLKC7_0/LDQ10	C	
16	VCC	-			VCC	-			
17	PL15A	6	PCLKT6_0	T (LVDS)*	PL15A	6	PCLKT6_0	T (LVDS)*	
18	PL15B	6	PCLKC6_0	C (LVDS)*	PL15B	6	PCLKC6_0	C (LVDS)*	
19	PL16A	6	VREF2_6	T	PL16A	6	VREF2_6	T	
20	PL16B	6	VREF1_6	C	PL16B	6	VREF1_6	C	
21	GND	-			GND	-			
22	VCC	-			VCC	-			
23	PL18A	6	LLM0_GDLLT_FB_A	T	PL18A	6	LLM0_GDLLT_FB_A	T	
24	PL18B	6	LLM0_GDLLC_FB_A	C	PL18B	6	LLM0_GDLLC_FB_A	C	
25	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
26	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	
27	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	
28	PL22A	6			PL22A	6			
29	VCC	-			VCC	-			
30	GND	-			GND	-			
31	VCCIO6	6			VCCIO6	6			
32	TCK	-			TCK	-			
33	TDI	-			TDI	-			
34	TDO	-			TDO	-			
35	VCCJ	-			VCCJ	-			
36	TMS	-			TMS	-			
37	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
38	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
39	VCCAUX	-			VCCAUX	-			
40	PB4A	5	BDQ6	T	PB6A	5	BDQS6	T	
41	PB4B	5	BDQ6	C	PB6B	5	BDQ6	C	
42	VCCIO5	5			VCCIO5	5			
43	PB6A	5	BDQS6	T	PB12A	5	BDQ15	T	
44	PB6B	5	BDQ6	C	PB12B	5	BDQ15	C	
45	NC	5			PB16A	5	BDQ15	T	

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D2	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7/LDQ6	T (LVDS)*	
D1	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7/LDQ6	C (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
F6	PL3A	7		T	PL3A	7	LDQ6	T	
F5	PL3B	7		C	PL3B	7	LDQ6	C	
VCCIO	VCCIO7	7			VCCIO7	7			
E4	NC	-			PL4A	7	LDQ6	T (LVDS)*	
E3	NC	-			PL4B	7	LDQ6	C (LVDS)*	
E2	NC	-			PL5A	7	LDQ6	T	
E1	NC	-			PL5B	7	LDQ6	C	
GND	GNDIO7	-			GNDIO7	-			
H6	NC	-			PL6A	7	LDQS6	T (LVDS)*	
H5	NC	-			PL6B	7	LDQ6	C (LVDS)*	
F2	NC	-			PL7A	7	LDQ6	T	
VCCIO	VCCIO7	7			VCCIO7	7			
F1	NC	-			PL7B	7	LDQ6	C	
H8	NC	-			PL8A	7	LDQ6	T (LVDS)*	
J9	NC	-			PL8B	7	LDQ6	C (LVDS)*	
G4	NC	-			PL9A	7	LDQ6	T	
GND	GNDIO7	-			GNDIO7	-			
G3	NC	-			PL9B	7	LDQ6	C	
H7	PL4A	7	LDQ8	T (LVDS)*	PL10A	7	LDQ14	T (LVDS)*	
J8	PL4B	7	LDQ8	C (LVDS)*	PL10B	7	LDQ14	C (LVDS)*	
G2	PL5A	7	LDQ8	T	PL11A	7	LDQ14	T	
G1	PL5B	7	LDQ8	C	PL11B	7	LDQ14	C	
H3	PL6A	7	LDQ8	T (LVDS)*	PL12A	7	LDQ14	T (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
H4	PL6B	7	LDQ8	C (LVDS)*	PL12B	7	LDQ14	C (LVDS)*	
J5	PL7A	7	LDQ8	T	PL13A	7	LDQ14	T	
J4	PL7B	7	LDQ8	C	PL13B	7	LDQ14	C	
J3	PL8A	7	LDQS8	T (LVDS)*	PL14A	7	LDQS14	T (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
K4	PL8B	7	LDQ8	C (LVDS)*	PL14B	7	LDQ14	C (LVDS)*	
H1	PL9A	7	LDQ8	T	PL15A	7	LDQ14	T	
H2	PL9B	7	LDQ8	C	PL15B	7	LDQ14	C	
VCCIO	VCCIO7	7			VCCIO7	7			
K6	PL10A	7	LDQ8	T (LVDS)*	PL16A	7	LDQ14	T (LVDS)*	
K7	PL10B	7	LDQ8	C (LVDS)*	PL16B	7	LDQ14	C (LVDS)*	
J1	PL11A	7	LDQ8	T	PL17A	7	LDQ14	T	
J2	PL11B	7	LDQ8	C	PL17B	7	LDQ14	C	
GND	GNDIO7	-			GNDIO7	-			
VCCIO	VCCIO7	7			VCCIO7	7			
K3	NC	-			NC	-			
K2	NC	-			NC	-			
GND	GNDIO7	-			GNDIO7	-			
K1	NC	-			NC	-			

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A2	GND	-			GND	-		
A25	GND	-			GND	-		
AA18	GND	-			GND	-		
AA24	GND	-			GND	-		
AA3	GND	-			GND	-		
AA9	GND	-			GND	-		
AD11	GND	-			GND	-		
AD16	GND	-			GND	-		
AD21	GND	-			GND	-		
AD6	GND	-			GND	-		
AE1	GND	-			GND	-		
AE26	GND	-			GND	-		
AF2	GND	-			GND	-		
AF25	GND	-			GND	-		
B1	GND	-			GND	-		
B26	GND	-			GND	-		
C11	GND	-			GND	-		
C16	GND	-			GND	-		
C21	GND	-			GND	-		
C6	GND	-			GND	-		
F18	GND	-			GND	-		
F24	GND	-			GND	-		
F3	GND	-			GND	-		
F9	GND	-			GND	-		
J13	GND	-			GND	-		
J14	GND	-			GND	-		
J21	GND	-			GND	-		
J6	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K13	GND	-			GND	-		
K14	GND	-			GND	-		
K16	GND	-			GND	-		
K17	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L16	GND	-			GND	-		
L17	GND	-			GND	-		
L24	GND	-			GND	-		
L3	GND	-			GND	-		
M13	GND	-			GND	-		
M14	GND	-			GND	-		
N10	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N14	GND	-			GND	-		

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D1	PL2A	7	LDQ6	T (LVDS)*	PL2A	7	LDQ6	T (LVDS)*	
E1	PL2B	7	LDQ6	C (LVDS)*	PL2B	7	LDQ6	C (LVDS)*	
F1	PL3A	7	LDQ6	T	PL3A	7	LDQ6	T	
F2	PL3B	7	LDQ6	C	PL3B	7	LDQ6	C	
F5	PL4A	7	LDQ6	T (LVDS)*	PL4A	7	LDQ6	T (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
G6	PL4B	7	LDQ6	C (LVDS)*	PL4B	7	LDQ6	C (LVDS)*	
F4	PL5A	7	LDQ6	T	PL5A	7	LDQ6	T	
F3	PL5B	7	LDQ6	C	PL5B	7	LDQ6	C	
G1	PL6A	7	LDQS6	T (LVDS)*	PL6A	7	LDQS6	T (LVDS)*	
GNDIO	GNDIO7	-			GNDIO7	-			
G2	PL6B	7	LDQ6	C (LVDS)*	PL6B	7	LDQ6	C (LVDS)*	
H1	PL7A	7	LDQ6	T	PL7A	7	LDQ6	T	
H2	PL7B	7	LDQ6	C	PL7B	7	LDQ6	C	
VCCIO	VCCIO7	7			VCCIO7	7			
H7	PL8A	7	LDQ6	T (LVDS)*	PL8A	7	LDQ6	T (LVDS)*	
H6	PL8B	7	LDQ6	C (LVDS)*	PL8B	7	LDQ6	C (LVDS)*	
G3	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7/LDQ6	T	
H3	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7/LDQ6	C	
GNDIO	GNDIO7	-			GNDIO7	-			
H5	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	
H4	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	
J1	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	
J2	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	
J3	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
J4	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*	
J7	PL14A	7		T	PL14A	7	LDQ15	T	
J6	PL14B	7		C	PL14B	7	LDQ15	C	
GNDIO	GNDIO7	-			GNDIO7	-			
VCCIO	VCCIO7	7			VCCIO7	7			
K1	PL18A	7	LUM1_SPLLT_IN_A/LDQ22	T (LVDS)*	PL28A	7	LUM1_SPLLT_IN_A/LDQ32	T (LVDS)*	
K2	PL18B	7	LUM1_SPLLC_IN_A/LDQ22	C (LVDS)*	PL28B	7	LUM1_SPLLC_IN_A/LDQ32	C (LVDS)*	
J5	PL19A	7	LUM1_SPLLT_FB_A/LDQ22	T	PL29A	7	LUM1_SPLLT_FB_A/LDQ32	T	
K5	PL19B	7	LUM1_SPLLC_FB_A/LDQ22	C	PL29B	7	LUM1_SPLLC_FB_A/LDQ32	C	
VCCIO	VCCIO7	7			VCCIO7	7			
K7	PL20A	7	LDQ22	T (LVDS)*	PL30A	7	LDQ32	T (LVDS)*	
K6	PL20B	7	LDQ22	C (LVDS)*	PL30B	7	LDQ32	C (LVDS)*	
L6	PL21A	7	LDQ22	T	PL31A	7	LDQ32	T	
L7	PL21B	7	LDQ22	C	PL31B	7	LDQ32	C	
GNDIO	GNDIO7	-			GNDIO7	-			
L1	PL22A	7	LDQS22	T (LVDS)*	PL32A	7	LDQS32	T (LVDS)*	
L2	PL22B	7	LDQ22	C (LVDS)*	PL32B	7	LDQ32	C (LVDS)*	
M7	PL23A	7	LDQ22	T	PL33A	7	LDQ32	T	
VCCIO	VCCIO7	7			VCCIO7	7			
L5	PL23B	7	LDQ22	C	PL33B	7	LDQ32	C	
L3	PL24A	7	LDQ22	T (LVDS)*	PL34A	7	LDQ32	T (LVDS)*	

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C29	URC_SQ_VCCR1	12		
B28	URC_SQ_HDINN1	12		C
C28	URC_SQ_VCCIB1	12		
A28	URC_SQ_HDINP1	12		T
B24	URC_SQ_VCCAUX33	12		
E24	URC_SQ_REFCLKN	12		C
D24	URC_SQ_REFCLKP	12		T
C24	URC_SQ_VCCP	12		
A20	URC_SQ_HDINP2	12		T
C20	URC_SQ_VCCIB2	12		
B20	URC_SQ_HDINN2	12		C
C19	URC_SQ_VCCR2	12		
A23	URC_SQ_HDOUTP2	12		T
C23	URC_SQ_VCCOB2	12		
B23	URC_SQ_HDOUTN2	12		C
C22	URC_SQ_VCCTX2	12		
B22	URC_SQ_HDOUTN3	12		C
A21	URC_SQ_VCCOB3	12		
A22	URC_SQ_HDOUTP3	12		T
C21	URC_SQ_VCCTX3	12		
B19	URC_SQ_HDINN3	12		C
B18	URC_SQ_VCCIB3	12		
A19	URC_SQ_HDINP3	12		T
C18	URC_SQ_VCCR3	12		
D23	PT100B	1		C
GNDIO	GNDIO1	-		
E21	PT100A	1		T
D26	PT99B	1		C
E26	PT99A	1		T
E23	PT98B	1		C
VCCIO	VCCIO1	1		
G22	PT98A	1		T
-	-	-		
D22	PT97B	1		C
F21	PT97A	1		T
G18	PT96B	1		C
H18	PT96A	1		T
D20	PT95B	1		C
GNDIO	GNDIO1	-		
D21	PT95A	1		T
E20	PT94B	1		C
VCCIO	VCCIO1	1		
E19	PT94A	1		T

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M23	GND	-		
M8	GND	-		
N14	GND	-		
N15	GND	-		
N16	GND	-		
N17	GND	-		
N27	GND	-		
N4	GND	-		
P11	GND	-		
P13	GND	-		
P14	GND	-		
P15	GND	-		
P16	GND	-		
P17	GND	-		
P18	GND	-		
P20	GND	-		
R10	GND	-		
R11	GND	-		
R13	GND	-		
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R20	GND	-		
R21	GND	-		
R24	GND	-		
R7	GND	-		
T10	GND	-		
T11	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T20	GND	-		
T21	GND	-		
T24	GND	-		
T7	GND	-		
U11	GND	-		
U13	GND	-		
U14	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U8	PL43B	7	LUM3_SPLLC_FB_A/LDQ46	C	PL51B	7	LUM3_SPLLC_FB_A/LDQ54	C
VCCIO	VCCIO7	7			VCCIO7	7		
T6	PL44A	7	LDQ46	T (LVDS)*	PL52A	7	LDQ54	T (LVDS)*
R6	PL44B	7	LDQ46	C (LVDS)*	PL52B	7	LDQ54	C (LVDS)*
U9	PL45A	7	LDQ46	T	PL53A	7	LDQ54	T
T7	PL45B	7	LDQ46	C	PL53B	7	LDQ54	C
GNDIO	GNDIO7	-			GNDIO7	-		
U5	PL46A	7	LDQS46	T (LVDS)*	PL54A	7	LDQS54	T (LVDS)*
U6	PL46B	7	LDQ46	C (LVDS)*	PL54B	7	LDQ54	C (LVDS)*
U7	PL47A	7	LDQ46	T	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7			VCCIO7	7		
V9	PL47B	7	LDQ46	C	PL55B	7	LDQ54	C
V11	PL48A	7	LDQ46	T (LVDS)*	PL56A	7	LDQ54	T (LVDS)*
V10	PL48B	7	LDQ46	C (LVDS)*	PL56B	7	LDQ54	C (LVDS)*
U4	PL49A	7	PCLKT7_0/LDQ46	T	PL57A	7	PCLKT7_0/LDQ54	T
GNDIO	GNDIO7	-			GNDIO7	-		
U3	PL49B	7	PCLKC7_0/LDQ46	C	PL57B	7	PCLKC7_0/LDQ54	C
U2	PL51A	6	PCLKT6_0/LDQ55	T (LVDS)*	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
U1	PL51B	6	PCLKC6_0/LDQ55	C (LVDS)*	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
V5	PL52A	6	VREF2_6/LDQ55	T	PL60A	6	VREF2_6/LDQ63	T
V6	PL52B	6	VREF1_6/LDQ55	C	PL60B	6	VREF1_6/LDQ63	C
V7	PL53A	6	LDQ55	T (LVDS)*	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
V8	PL53B	6	LDQ55	C (LVDS)*	PL61B	6	LDQ63	C (LVDS)*
V4	PL54A	6	LDQ55	T	PL62A	6	LDQ63	T
V3	PL54B	6	LDQ55	C	PL62B	6	LDQ63	C
V2	PL55A	6	LDQS55	T (LVDS)*	PL63A	6	LDQS63	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
V1	PL55B	6	LDQ55	C (LVDS)*	PL63B	6	LDQ63	C (LVDS)*
W7	PL56A	6	LDQ55	T	PL64A	6	LDQ63	T
W5	PL56B	6	LDQ55	C	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6			VCCIO6	6		
W2	PL57A	6	LLM3_SPLLT_IN_A/LDQ55	T (LVDS)*	PL65A	6	LLM4_SPLLT_IN_A/LDQ63	T (LVDS)*
W1	PL57B	6	LLM3_SPLLC_IN_A/LDQ55	C (LVDS)*	PL65B	6	LLM4_SPLLC_IN_A/LDQ63	C (LVDS)*
Y6	PL58A	6	LLM3_SPLLT_FB_A/LDQ55	T	PL66A	6	LLM4_SPLLT_FB_A/LDQ63	T
W6	PL58B	6	LLM3_SPLLC_FB_A/LDQ55	C	PL66B	6	LLM4_SPLLC_FB_A/LDQ63	C
GNDIO	GNDIO6	-			GNDIO6	-		
Y1	PL60A	6	LDQ64	T (LVDS)*	PL68A	6	LDQ72	T (LVDS)*
Y2	PL60B	6	LDQ64	C (LVDS)*	PL68B	6	LDQ72	C (LVDS)*
Y7	PL61A	6	LDQ64	T	PL69A	6	LDQ72	T
Y5	PL61B	6	LDQ64	C	PL69B	6	LDQ72	C
VCCIO	VCCIO6	6			VCCIO6	6		
W10	PL62A	6	LDQ64	T (LVDS)*	PL70A	6	LDQ72	T (LVDS)*
Y8	PL62B	6	LDQ64	C (LVDS)*	PL70B	6	LDQ72	C (LVDS)*
Y4	PL63A	6	LDQ64	T	PL71A	6	LDQ72	T
Y3	PL63B	6	LDQ64	C	PL71B	6	LDQ72	C
GNDIO	GNDIO6	-			GNDIO6	-		
AA1	PL64A	6	LDQS64	T (LVDS)*	PL72A	6	LDQS72	T (LVDS)*
AA2	PL64B	6	LDQ64	C (LVDS)*	PL72B	6	LDQ72	C (LVDS)*

LatticeECP2 Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144C	90	1.2V	-5	TQFP	144	COM	6
LFE2-6E-6T144C	90	1.2V	-6	TQFP	144	COM	6
LFE2-6E-7T144C	90	1.2V	-7	TQFP	144	COM	6
LFE2-6E-5F256C	190	1.2V	-5	fpBGA	256	COM	6
LFE2-6E-6F256C	190	1.2V	-6	fpBGA	256	COM	6
LFE2-6E-7F256C	190	1.2V	-7	fpBGA	256	COM	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144C	93	1.2V	-5	TQFP	144	COM	12
LFE2-12E-6T144C	93	1.2V	-6	TQFP	144	COM	12
LFE2-12E-7T144C	93	1.2V	-7	TQFP	144	COM	12
LFE2-12E-5Q208C	131	1.2V	-5	PQFP	208	COM	12
LFE2-12E-6Q208C	131	1.2V	-6	PQFP	208	COM	12
LFE2-12E-7Q208C	131	1.2V	-7	PQFP	208	COM	12
LFE2-12E-5F256C	193	1.2V	-5	fpBGA	256	COM	12
LFE2-12E-6F256C	193	1.2V	-6	fpBGA	256	COM	12
LFE2-12E-7F256C	193	1.2V	-7	fpBGA	256	COM	12
LFE2-12E-5F484C	297	1.2V	-5	fpBGA	484	COM	12
LFE2-12E-6F484C	297	1.2V	-6	fpBGA	484	COM	12
LFE2-12E-7F484C	297	1.2V	-7	fpBGA	484	COM	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208C	131	1.2V	-5	PQFP	208	COM	20
LFE2-20E-6Q208C	131	1.2V	-6	PQFP	208	COM	20
LFE2-20E-7Q208C	131	1.2V	-7	PQFP	208	COM	20
LFE2-20E-5F256C	193	1.2V	-5	fpBGA	256	COM	20
LFE2-20E-6F256C	193	1.2V	-6	fpBGA	256	COM	20
LFE2-20E-7F256C	193	1.2V	-7	fpBGA	256	COM	20
LFE2-20E-5F484C	331	1.2V	-5	fpBGA	484	COM	20
LFE2-20E-6F484C	331	1.2V	-6	fpBGA	484	COM	20
LFE2-20E-7F484C	331	1.2V	-7	fpBGA	484	COM	20
LFE2-20E-5F672C	402	1.2V	-5	fpBGA	672	COM	20
LFE2-20E-6F672C	402	1.2V	-6	fpBGA	672	COM	20
LFE2-20E-7F672C	402	1.2V	-7	fpBGA	672	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208I	131	1.2V	-5	PQFP	208	IND	20
LFE2-20E-6Q208I	131	1.2V	-6	PQFP	208	IND	20
LFE2-20E-5F256I	193	1.2V	-5	fpBGA	256	IND	20
LFE2-20E-6F256I	193	1.2V	-6	fpBGA	256	IND	20
LFE2-20E-5F484I	331	1.2V	-5	fpBGA	484	IND	20
LFE2-20E-6F484I	331	1.2V	-6	fpBGA	484	IND	20
LFE2-20E-5F672I	402	1.2V	-5	fpBGA	672	IND	20
LFE2-20E-6F672I	402	1.2V	-6	fpBGA	672	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5F484I	331	1.2V	-5	fpBGA	484	IND	35
LFE2-35E-6F484I	331	1.2V	-6	fpBGA	484	IND	35
LFE2-35E-5F672I	450	1.2V	-5	fpBGA	672	IND	35
LFE2-35E-6F672I	450	1.2V	-6	fpBGA	672	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5F484I	339	1.2V	-5	fpBGA	484	IND	50
LFE2-50E-6F484I	339	1.2V	-6	fpBGA	484	IND	50
LFE2-50E-5F672I	500	1.2V	-5	fpBGA	672	IND	50
LFE2-50E-6F672I	500	1.2V	-6	fpBGA	672	IND	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5F672I	500	1.2V	-5	fpBGA	672	IND	70
LFE2-70E-6F672I	500	1.2V	-6	fpBGA	672	IND	70
LFE2-70E-5F900I	583	1.2V	-5	fpBGA	900	IND	70
LFE2-70E-6F900I	583	1.2V	-6	fpBGA	900	IND	70